

Plating min - Mating	0.889μm
Plating min - Termination	0.889μm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	No
Temperature Range - Operating	-40° to +105°C
Termination Interface: Style	Through Hole
<b>Electrical</b>	
Current - Maximum per Contact	9.0A
Voltage - Maximum	600V
<b>Solder Process Data</b>	
Duration at Max. Process Temperature (seconds)	005
Lead-freeProcess Capability	WAVE
Max. Cycles at Max. Process Temperature	001
Process Temperature max. C	240
<b>Material Info</b>	
Engineering Number	5566-04B2
<b>Reference - Drawing Numbers</b>	
Application Specification	AS-5557-001-001, AS-5566-001-001
Packaging Specification	PK-5566-001-001
Product Specification	PS-5556-001-001
Sales Drawing	55660021-SD-000
Test Summary	TS-5556-002-001, TS-5566-002-001

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